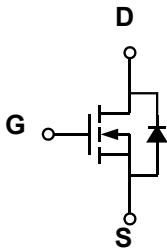


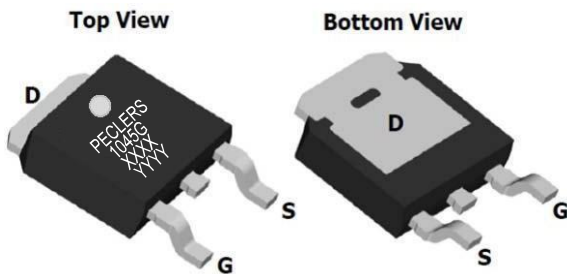
## 100V N-Channel SGT Enhancement Mode MOSFET

### Schematic diagram



### Marking and pin assignment

TO-252-2L



Note:

XXXX—Wafer Information

YYYY—Quality Code



### Description

The PECN1045G uses Shield Gate Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

### General Features

- ◆  $V_{DS} = 100V$   $I_D = 45A$   
 $R_{DS(ON)}(Typ.) = 14.0m\Omega$  @  $V_{GS} = 10V$   
 $R_{DS(ON)}(Typ.) = 18.5m\Omega$  @  $V_{GS} = 4.5V$
- ◆ Excellent gate charge x  $R_{DS(on)}$  product(FOM)
- ◆ Very low on-resistance  $R_{DS(on)}$
- ◆ 150 °C operating temperature
- ◆ 100% UIS tested

*100% UIS TESTED!*

*100%  $\Delta V_{ds}$  TESTED!*

### Application

- ◆ Synchronous Rectification in DC/DC and AC/DC Converters
- ◆ Industrial and Motor Drive applications

### Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN1045G	-55°C to +150°C	TO-252-2L	2500

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	$V_{DS}$	100	V
Gate-source voltage	$V_{GS}$	±20	V
Continuous Drain Current	$I_D$	TC=25°C	45
		TC=70°C	36
Pulsed Drain Current	$I_{DP}$	180	A
Avalanche energy(L=0.5mH) <small>(note1)</small>	$E_{AS}$	200	mJ
Power Dissipation	$P_D$	TC=25°C	85
		TC=70°C	45
Operating junction Temperature range	$T_j$	-55—150	°C

## Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	100	-	-	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C	-	-	1	μA
			-	-	5	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.75	2.5	V
Drain-source on-state resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =45A	-	14.0	18	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =30A		18.5	24	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =20A	-	35	-	S
<b>Diode Characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	I <sub>SD</sub> =1A, V <sub>GS</sub> =0V	-	0.7	1.2	V
Diode Continuous Forward Current	I <sub>S</sub>		-	-	60	A
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> =45A di/dt = 100A/μs	-	25	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		-	80	-	nC
<b>Dynamic Characteristics<sup>2</sup></b>						
Gate Resistance	R <sub>G</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	-	1.2	1.8	Ω
Input capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =50V f=1.0MHz	-	1600	-	pF
Output capacitance	C <sub>OSS</sub>		-	140	-	
Reverse transfer capacitance	C <sub>RSS</sub>		-	11	-	
Turn-on delay time	t <sub>D(ON)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, R <sub>L</sub> =2.5Ω, R <sub>G</sub> =3Ω	-	6	-	ns
Turn-on Rise time	t <sub>r</sub>		-	2	-	
Turn-off delay time	t <sub>D(OFF)</sub>		-	18	-	
Turn-off Fall time	t <sub>f</sub>		-	2	-	
Total gate charge	Q <sub>g</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =20A	-	26	-	nC
Gate-source charge	Q <sub>gs</sub>		-	7.4	-	
Gate-drain charge	Q <sub>gd</sub>		-	3.8	-	

Note: 1: Pulse test; pulse width ≤ 300ns, duty cycle ≤ 2%.

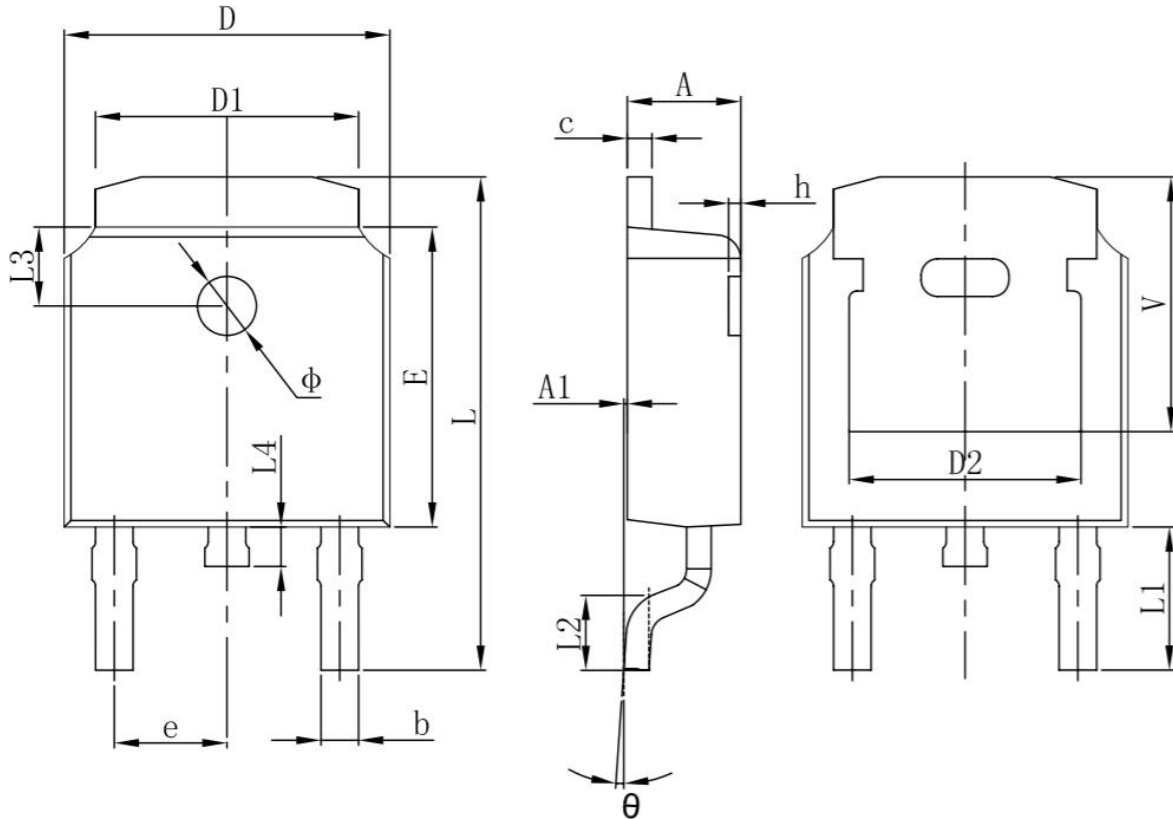
2: Guaranteed by design, not subject to production testing.

## Thermal Characteristics

Parameter	Symbol	Typical	Unit
Thermal Resistance-Junction to Case	R <sub>θJC</sub>	1.7	°C/W
Thermal Resistance junction-to ambient	R <sub>θJA</sub>	62.5	

### Package Information

- TO-252-2L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	